

12/21/08

	Class	Subclass
ISSUE CLASSIFICATION		

PATENT NUMBER

U.S. **UTILITY** Patent Application

O.I.P.E. RW SCANNED 1854 Q.A. 1A	PATENT DATE
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APPLICATION NO. 09/746976	CONT/PRIOR	CLASS 257	SUBCLASS 180	ART UNIT 2811 2829	EXAMINER Trent H. D.
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**APPLICANTS**  
Burton Carpenter  
Nhat Vo  
Christopher Clark  
William Stone

Apparatus for connecting a semiconductor die to a substrate and  
method therefor

**TITLE**

PTO-2040  
12/99

ISSUING CLASSIFICATION												
ORIGINAL					CROSS REFERENCE(S)							
CLASS		SUBCLASS			CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)						
INTERNATIONAL CLASSIFICATION												

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<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>	<b>DRAWINGS</b>		<b>CLAIMS ALLOWED</b>	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner) (Date)		<b>NOTICE OF ALLOWANCE MAILED</b>	
	_____ (Primary Examiner) (Date)		<b>ISSUE FEE</b>	
Amount Due			Date Paid	
<input type="checkbox"/> The terminal ____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner) (Date)		<b>ISSUE BATCH NUMBER</b>	
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